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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/669,063	09/23/2003	Mohamad A. Shaheen	42P15990	2742
8791	7590 03/21/2006		EXAMINER	
BLAKELY SOKOLOFF TAYLOR & ZAFMAN 12400 WILSHIRE BOULEVARD SEVENTH FLOOR			TRAN, BINH X	
			ART UNIT	PAPER NUMBER
LOS ANGEI	LOS ANGELES, CA 90025-1030 -		1765	
			DATE MAILED: 03/21/2006	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)				
Advisory Action	10/669,063	SHAHEEN, MOHAMAD A.				
Before the Filing of an Appeal Brief	Examiner	Art Unit				
	Binh X. Tran	1765				
The MAILING DATE of this communication appe	ars on the cover sheet with the o	correspondence address				
THE REPLY FILED 06 March 2006 FAILS TO PLACE THIS APPLICATION IN CONDITION FOR ALLOWANCE.						
1. The reply was filed after a final rejection, but prior to or on the same day as filing a Notice of Appeal. To avoid abandonment of						
this application, applicant must timely file one of the follo places the application in condition for allowance; (2) a No (3) a Request for Continued Examination (RCE) in completely following time periods:	wing replies: (1) an amendment, a otice of Appeal (with appeal fee) in liance with 37 CFR 1.114. The repl	ffidavit, or other evidence, which compliance with 37 CFR 41.31; or				
a) The period for reply expires 3 months from the mailing date of	•					
b) The period for reply expires on: (1) the mailing date of this Advievent, however, will the statutory period for reply expire later the Examiner Note: If box 1 is checked, check either box (a) or (b).	an SIX MONTHS from the mailing date o	f the final rejection.				
MONTHS OF THE FINAL REJECTION. See MPEP 706.07(f)).					
Extensions of time may be obtained under 37 CFR 1.136(a). The date on been filed is the date for purposes of determining the period of extension a CFR 1.17(a) is calculated from: (1) the expiration date of the shortened sta above, if checked. Any reply received by the Office later than three months earned patent term adjustment. See 37 CFR 1.704(b). NOTICE OF APPEAL	nd the corresponding amount of the fee. atutory period for reply originally set in the	The appropriate extension fee under 37 final Office action; or (2) as set forth in (b)				
2. The Notice of Appeal was filed on A brief in compliance with 37 CFR 41.37 must be filed within two months of the date of filing the Notice of Appeal (37 CFR 41.37(a)), or any extension thereof (37 CFR 41.37(e)), to avoid dismissal of the appeal. Since a Notice of Appeal has been filed, any reply must be filed within the time period set forth in 37 CFR 41.37(a). AMENDMENTS						
	but prior to the date of filing a brie	f will not be entered because				
(a) They raise new issues that would require further consideration and/or search (see NOTE below);						
(b) They raise the issue of new matter (see NOTE below);						
(c) ☐ They are not deemed to place the application in better form for appeal by materially reducing or simplifying the issues for appeal; and/or						
(d) They present additional claims without canceling a corresponding number of finally rejected claims.						
NOTE: (See 37 CFR 1.116 and 41.33(a)).						
1. The amendments are not in compliance with 37 CFR 1.121. See attached Notice of Non-Compliant Amendment (PTOL-324)						
5. Applicant's reply has overcome the following rejection(s):						
6. Newly proposed or amended claim(s) would be allowable if submitted in a separate, timely filed amendment canceling the non-allowable claim(s).						
7. For purposes of appeal, the proposed amendment(s): a) will not be entered, or b) will be entered and an explanation of how the new or amended claims would be rejected is provided below or appended. The status of the claim(s) is (or will be) as follows:						
Claim(s) allowed: Claim(s) objected to:						
Claim(s) rejected: Claim(s) withdrawn from consideration:						
AFFIDAVIT OR OTHER EVIDENCE						
8. The affidavit or other evidence filed after a final action, but	ut before or on the date of filing a N	Notice of Appeal will <u>not</u> be entered				
because applicant failed to provide a showing of good an and was not earlier presented. See 37 CFR 1.116(e).						
9. The affidavit or other evidence filed after the date of filing a Notice of Appeal, but prior to the date of filing a brief, will <u>not</u> be entered because the affidavit or other evidence failed to overcome <u>all</u> rejections under appeal and/or appellant fails to provide a showing a good and sufficient reasons why it is necessary and was not earlier presented. See 37 CFR 41.33(d)(1).						
10. The affidavit or other evidence is entered. An explanation of the status of the claims after entry is below or attached.						
REQUEST FOR RECONSIDERATION/OTHER 11. The request for reconsideration has been considered but does NOT place the application in condition for allowance						
because:						
See Continuation Sheet.						
12. Note the attached Information Disclosure Statement(s). (PTO/SB/08 or PTO-1449) Paper No(s).						

13. Other: ____.

SUPERVISORS EXAMINER

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Continuation of 11. does NOT place the application in condition for allowance because: The applicant argue that "Leitz teaches forming a silicon germanium layer, but the Patent Office has not identified, and Applicants is unable to find any teaching in Leitz of removing and smoothing as claimed". The examiner disagrees with this argument. In paragraph 30-32, Leitz teaches to form silicon germanium. In paragraph 34, Leitz teaches to control temperature to permits deposition of "planar" SiGe. The examiner interprets the term "planar" means flat or smooth. Therefore, Leitz clearly teaches to form SiGe and smoothing the SiGe layer in the same chamber. The examiner recognizes that Leitz does not teach removing the SiGe layer. However, The limitation regarding removing and smoothing the silicon germanium layer in the same chamber has been discussed in Thilderkvist's reference.

In page 8 of the remark, the applicants argue that "the combination is improper, as Thilderkvist teaches against forming in the same processing chamber that used to remove and smooth". The examiner disagrees. Teaching one way does not means teaching away. The examiner still maintains that it is obvious to perform in the same chamber because it will save cost, processing time on wafer handling.

The applicant further argues that "the Patent Office has not identified, and Applicant is unable to find any teaching in Thilderkvist of smooth FOLLOWING removing as claimed" (emphasis added). This argument does not commensurate with the scope of claim. There is no limitation in the claim to indicate the order between the removing and smoothing step. The applicant recites the method comprising removing step and smoothing step in the same chamber.

Binh X. Tram